

L Number	Hits	Search Text	DB	Time stamp
2	14787	(ball or bump) near (transfer\$6 or placing or place\$4 or arraying)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/26 07:38
3	92	((ball or bump) near (transfer\$6 or placing or place\$4 or arraying)) and (bath or pool or plate or tray or reservoir or tank or dip\$6 or immers\$6 or submer\$6) near (flux\$6 or electrolyt\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/26 07:42
6	1414	((ball or bump) near (transfer\$6 or placing or place\$4 or arraying)) and (flux\$6 or electrolyt\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/26 08:02
7	92	((ball or bump) near (transfer\$6 or placing or place\$4 or arraying)) and (flux\$6 or electrolyt\$4)) and drain\$6	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/26 07:43
8	5	((((ball or bump) near (transfer\$6 or placing or place\$4 or arraying)) and (flux\$6 or electrolyt\$4)) and drain\$6) and off near (set or center)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/26 07:43
9	3	((((ball or bump) near (transfer\$6 or placing or place\$4 or arraying)) and (flux\$6 or electrolyt\$4)) and drain\$6) and diffusion adj bond\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/26 07:44
10	74	((((ball or bump) near (transfer\$6 or placing or place\$4 or arraying)) and (bath or pool or plate or tray or reservoir or tank or dip\$6 or immers\$6 or submer\$6) near (flux\$6 or electrolyt\$4)) or (((ball or bump) near (transfer\$6 or placing or place\$4 or arraying)) and (flux\$6 or electrolyt\$4)) and drain\$6)) and (wafer or pallet)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/26 07:50
13	24	((ball or bump) near (transfer\$6 or placing or place\$4 or arraying)) and (flux\$6 or electrolyt\$4)) and (substrate or board or pcb or pwb or dip\$6 or immers\$6 or submer\$6) near (inclin\$6 or angl\$4 or tilt\$4 or pivot\$4 or rotary or rotat\$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/26 08:01
14	43	((ball or bump) near (transfer\$6 or placing or place\$4 or arraying)) and (flux\$6 or electrolyt\$4)) and (substrate or board or pcb or pwb or dip\$6 or immers\$6 or submer\$6 or table) near (inclin\$6 or angl\$4 or tilt\$4 or pivot\$4 or rotary or rotat\$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/26 08:01
15	264	((ball or bump) near (transfer\$6 or placing or place\$4 or arraying)) and (substrate or board or pcb or pwb or dip\$6 or immers\$6 or submer\$6 or table) near (inclin\$6 or angl\$4 or tilt\$4 or pivot\$4 or rotary or rotat\$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/26 08:01
16	14	((ball or bump) near (transfer\$6 or placing or place\$4 or arraying)) and (bath or pool or plate or tray or reservoir or tank or dip\$6 or immers\$6 or submer\$6) near (flux\$6 or electrolyt\$4)) and (((ball or bump) near (transfer\$6 or placing or place\$4 or arraying)) and (substrate or board or pcb or pwb or dip\$6 or immers\$6 or submer\$6 or table) near (inclin\$6 or angl\$4 or tilt\$4 or pivot\$4 or rotary or rotat\$6))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/05/26 08:02